Datasheet for part number CIR030FFP-18-1P-F80

Our Catalog Part Number: CIR030FFP-18-1P-F80

 $\ \, \text{Brand: VEAM } \ \, \text{Product Category: Circular} \ \, \text{Product Line: Veam CIR, VBN, Other} \ \, \text{Series: CIR / FRCIR}$

Product Datasheet	
SERIES	Connector with Bayonet Coupling
Shell Style	Rear Mount Receptacle - Square flange, with rear thread
Mounting	Flange with through mounting hole
Environmental Class	Backshell with A style clamp and bushing but includes wire sealing grommet and compression ring.
Shell Size	18
Contact Arrangement	18-1
Total Number of contacts	10 contacts
Number of Contacts Size 16	10 contacts size 16
Gender	Pin
Contact Type	Crimp for AWG wire (used in F80 insert)
Contact Plating	Silver
Contact Material	Copper alloy
Shell Material	Aluminium alloy
Shell Plating	Chromate over Cadmium, olive drab, min. 500h salt spray resistance, conductive
Insulator Material	Chloroprene rubber
Wire Size Cross Section for Contacts Size 16	1,0-1,5 mm² or AWG 18-16
Contact Rating for Contacts Size 16	Maximum Current = 22 A Rated and Test Current = 13 A Potential Drop max. 74 mV
Shock Resistance	Waterproof to 10 meteres (33 ft) 12 h (14.7 PSI)
Coupling	2000 couplings minimum
Service Rating Letter	differs by position of contact - consult factory or refer to catalog
Operating Voltage DC	differs by position of contact - consult factory or refer to catalog
Operating Voltage AC	differs by position of contact - consult factory or refer to catalog
Dielectric strength - Minimum Flashover AC RMS	differs by position of contact - consult factory or refer to catalog
Dielectric strength - Test Voltage AC RMS (Hi Pot)	differs by position of contact - consult factory or refer to catalog
Note	Voltages in excess of 30 V ac or 42.5 V dc are potentially hazardous and care should be taken to ensure that such voltages can't be transmitted in any way to exposed metal parts of the connector body.
General	Veam CIR series Connectors are produced in accordance with NATO Standard VG95234, which is based on MIL-C-5015 for physical size, layout and environment requirements.